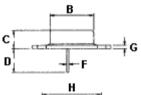


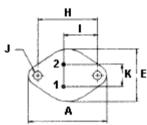


#### Features:

- High Gain Darlington performance
- High DC Current Gain:  $h_{FE}$  = 1,000 (Minimum) at  $I_C$  = 25 A,  $h_{FF}$  = 400 (Minimum) at  $I_C$  = 50 A
- Monolithic construction with built-in Base-Emitter Shunt Resistor

Complementary Silicon Power Darlington Transistors are designed for use as output devices in complementary general purpose amplifier applications





Pin 1. Base 2. Emitter Collector (Case)

Dimensions	Minimum	Maximum	
А	38.75	39.96	
В	19.28	22.23	
С	7.96	9.28	
D	11.18	12.19	
Е	25.2	26.67	
F	0.92	1.09	
G	1.38	1.62	
Н	29.9	30.4	
I	16.64	17.3	
J	3.88	4.36	
K	10.67	11.18	

Dimensions: Millimetres

NPN PNP MJ11032 MJ11033

50 Amperes Complementary Silicon Power Darlington Transistors 120 V 300 W



**TO-3** 

### **Maximum Ratings**

Characteristic	Symbol	Rating	Unit	
Collector - Emitter Voltage	$V_{CEO}$	120		
Collector - Base Voltage	$V_{CBO}$	120	V	
Emitter - Base Voltage	$V_{EBO}$	5		
Collector Current - Continuous - Peak	I <sub>C</sub> I <sub>CM</sub>	50 100	А	
Base Current	I <sub>B</sub>	2		
Total Power Dissipation at T <sub>C</sub> = 25 °C Derate above 25 °C	P <sub>D</sub>	300 1.71	W W/°C	
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +200	°C	

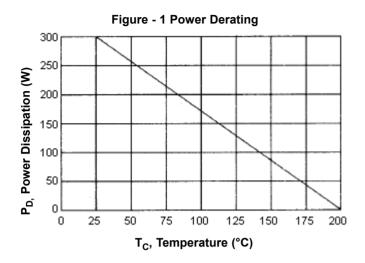
#### **Thermal Characteristics**

Characteristic	Symbol	Maximum	Unit
Thermal Resistance Junction to Case	Rθjc	0.584	°C / W

www.element14.com www.farnell.com www.newark.com







## Electrical Characteristics (T<sub>c</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Minimum	Maximum	Unit	
OFF Characteristics					
Collector - Emitter Sustaining Voltage (1) (I <sub>C</sub> = 100 mA, I <sub>B</sub> = 0)	V <sub>CEO (sus)</sub>	120	-	V	
Collector Cut off Current (V <sub>CE</sub> = 50 V, I <sub>B</sub> = 0)	I <sub>CEO</sub>	-	2	mA	
Collector - Emitter Leakage Current ( $V_{CE}$ = 120 V, $R_{BE}$ = 1 k $\Omega$ ) ( $V_{CE}$ = 120 V, $R_{BE}$ = 1 k $\Omega$ , $T_{C}$ = 125 °C)	I <sub>CER</sub>	-	2 10		
Emitter Cut off Current (V <sub>EB</sub> = 5 V, I <sub>C</sub> = 0)	I <sub>EBO</sub>	-	5		
ON Characteristics (1)					
DC Current Gain ( $I_C = 25 \text{ A}, V_{CE} = 5 \text{ V}$ ) ( $I_C = 50 \text{ A}, V_{CE} = 5 \text{ V}$ )	h <sub>FE</sub>	1,000 400	18,000	-	
Collector - Emitter Saturation Voltage ( $I_C = 25 \text{ A}, I_B = 250 \text{ mA}$ ) ( $I_C = 50 \text{ A}, I_B = 500 \text{ mA}$ )	V <sub>CE (sat)</sub>	-	2.5 3.5	V	
Base - Emitter Saturation Voltage ( $I_C$ = 25 A, $I_B$ = 200 mA) ( $I_C$ = 50 A, $I_B$ = 300 mA)	V <sub>BE (sat)</sub>	-	3 4.5	V	
Dynamic Characterisitics					
Small - Signal Current Gain (I <sub>C</sub> = 10 A, V <sub>CE</sub> = 3 V, f = 1 MHz)	h <sub>fe</sub>	4	-	-	

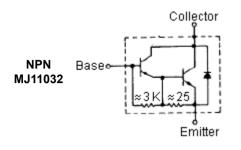
<sup>(1)</sup> Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$ 2%

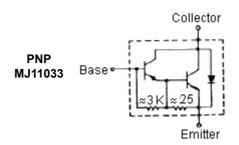


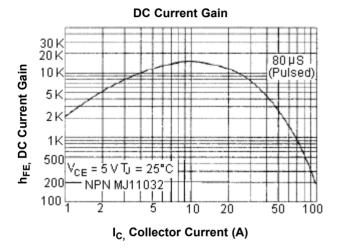
<sup>(2)</sup>  $f_T = |h_{fe}| \cdot f_{test}$ 

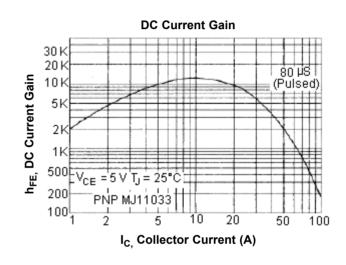


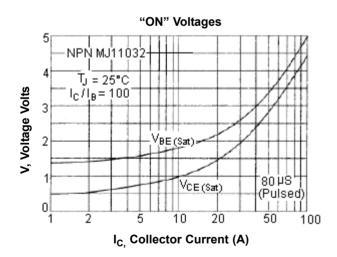
### **Internal Schematic Diagram**

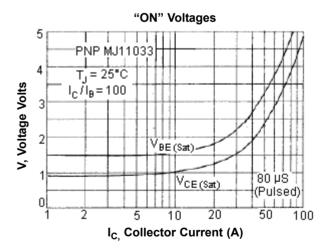








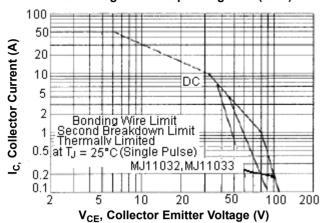








#### **Active-Region Safe Operating Area (SOA)**



There are two limitations on the power handling ability of a transistor average junction temperature and second breakdown safe operating area curves indicate  $I_{C}$  -  $V_{CE}$  limits of the transistor that must be observed for reliable operation i.e, the transistor must not be subjected to greater dissipation than the curves indicate

The data of SOA curve is based on  $T_{J(PK)}$  = 200°C;  $T_C$  is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided  $T_{J(PK)} \le 200$ °C, At high case temperatures, thermal limitation will reduce the power that can be handled to values less than the limitations imposed by second breakdown

#### **Specification Table**

I <sub>C (av)</sub> maximum (A)	V <sub>CEO</sub> maximum (V)	h <sub>FE</sub> minimum at I <sub>C</sub> = 25 A	P <sub>tot</sub> at 25°C (W)	Package	Туре	Part Number
50	50 120	1,000	300	TO-3	NPN	MJ11032
30 120	1,000	300	10-3	PNP	MJ11033	

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